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Coupling X-ray Beam Induced Current ToF-XBIC with high time resolution to characterize semiconductor-based detectors

Recently the demand for accurate characterization of the electronic properties of semiconductor-based detectors is steadily increasing. In this context, at the beamline BM05 of the EU synchrotron, we have developed an X-Ray Beam Induced Current (XBIC) [1] and a Time of Flight X-Ray Beam Induced Current (ToF XBIC) experiment setup. These two methods involve recording two-dimensional current maps (XBIC) and/or time resolution (ToF-XBIC) to assess the homogeneity of the crystal's response of local electrical property. Furthermore, by leveraging Bragg diffraction imaging technique [3] on the same beamline, we have demonstrated correlations between these techniques, revealing insights into charge collection attenuation, intrinsic time resolution, and structural defects at a percent level accuracy [1].

Achieving precise mapping of the crystal's intrinsic temporal resolution with local precision necessitates superior electronics to minimize measurement interference, along with high-intensity X-ray beams to enhance the signal-to-noise ratio and enable large-scale resolution (30 μm). This beam intensity can be attained using a multilayer monochromator which can gain 102 times the flux of a Si(111) monochromator. Control over the amount of signal generated within the semiconductor is crucial to have a good signal to noise ratio. Slits placed just in front of the sample can select the fraction of the transmitted beam down to 10 μm^2 , although this approach also dictates the resolution of the map. Alternatively, adjusting the beam energy within the range of 5 to 60 keV can influence the fraction of absorbed radiation. This provides sufficient signal for straightforward reading electronics comprising a preamplifier and an oscilloscope. Synchronizing measurements with the synchrotron frequency can compensate for smaller signals in large-gap semiconductors.

Our studies with XBIC and ToF-XBIC have shown the effects of the irradiation on single crystal diamond (sCVD) with a 68 MeV proton beam at ARRANAX, resulting in a notable decrease in charge collection and an increase in intrinsic time resolution dependent on the received fluence, as depicted in Figure 1 (attached document).

These integrated quantitative imaging techniques (XBIC, ToF XBIC, and X-ray diffraction imaging) offer valuable insights for optimizing not only for diamond crystals but also for all semiconductor: from bulk materials, thin overgrown layer to final devices in the order to understand better the success or failure of the electronic devices.

[1] Gallin-Martel, M.-L. et al. *Diamond and Related Materials* 112 108236 (2021).

[2] Lafont, F et al., *Diamond & Related Materials* 140 110454 (2023)

[3] T-N TranThi et al., *J. Appl. Cryst.* 50, 561-569 (2017).

I plan to submit also conference proceedings

Yes

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